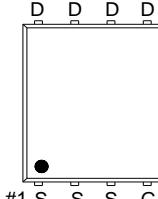
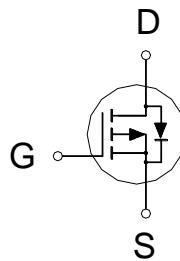


**NIKO-SEM**
**P-Channel Enhancement Mode  
Field Effect Transistor**
**P7510EK**  
**PDFN 5x6P**  
**Halogen-Free & Lead-Free**
**PRODUCT SUMMARY**

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
-100V	75mΩ	-19A


1. GATE  
2. DRAIN  
3. SOURCE
**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		$V_{DS}$	-100	V
Gate-Source Voltage		$V_{GS}$	$\pm 25$	
Continuous Drain Current	$T_C = 25^\circ\text{C}$	$I_D$	-19	
	$T_C = 100^\circ\text{C}$		-12	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	-45	
Continuous Drain Current	$T_A = 25^\circ\text{C}$	$I_D$	-4.4	
	$T_A = 70^\circ\text{C}$		-3.5	
Avalanche Current		$I_{AS}$	-15	
Avalanche Energy	$L = 1\text{mH}$	$E_{AS}$	113	mJ
Power Dissipation	$T_C = 25^\circ\text{C}$	$P_D$	60	W
	$T_C = 100^\circ\text{C}$		24	
Power Dissipation <sup>3</sup>	$T_A = 25^\circ\text{C}$	$P_D$	3.1	W
	$T_A = 70^\circ\text{C}$		2	
Operating Junction & Storage Temperature Range		$T_j, T_{stg}$	-55 to 150	°C

**THERMAL RESISTANCE RATINGS**

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient <sup>2</sup>	$t \leq 10\text{s}$	$R_{\theta JA}$	40	78	°C / W
Junction-to-Ambient <sup>2</sup>	Steady-State	$R_{\theta JA}$			
Junction-to-Case	Steady-State	$R_{\theta JC}$			

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

<sup>3</sup>The Power dissipation is based on  $R_{\theta JA}$   $t \leq 10\text{s}$  value.

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**ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25 °C, Unless Otherwise Noted)**

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-100			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-1.3	-1.8	-2.3	
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±25V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -100V, V <sub>GS</sub> = 0V			-1	
		V <sub>DS</sub> = -100V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 55 °C			-10	μA
Drain-Source On-State Resistance <sup>1</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -10A		62	85	
		V <sub>GS</sub> = -10V, I <sub>D</sub> = -10A		57	75	mΩ
Forward Transconductance <sup>1</sup>	g <sub>fs</sub>	V <sub>DS</sub> = -5V, I <sub>D</sub> = -10A		32		S
<b>DYNAMIC</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = -50V, f = 1MHz		2301		pF
Output Capacitance	C <sub>oss</sub>			117		
Reverse Transfer Capacitance	C <sub>rss</sub>			82		
Gate Resistance	R <sub>g</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0V, f = 1MHz		7.8		Ω
Total Gate Charge <sup>2</sup>	Q <sub>g</sub> (V <sub>GS</sub> =-10V)	V <sub>DS</sub> = -50V, V <sub>GS</sub> = -10V, I <sub>D</sub> = -10A		48		nC
	Q <sub>g</sub> (V <sub>GS</sub> =-4.5V)			25		
Gate-Source Charge <sup>2</sup>	Q <sub>gs</sub>			6		
Gate-Drain Charge <sup>2</sup>	Q <sub>gd</sub>			12		
Turn-On Delay Time <sup>2</sup>	t <sub>d(on)</sub>	V <sub>DS</sub> = -50V, I <sub>D</sub> ≈ -10A, V <sub>GS</sub> = -10V, R <sub>GEN</sub> = 6Ω		11		nS
Rise Time <sup>2</sup>	t <sub>r</sub>			38		
Turn-Off Delay Time <sup>2</sup>	t <sub>d(off)</sub>			116		
Fall Time <sup>2</sup>	t <sub>f</sub>			86		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T<sub>J</sub> = 25 °C)</b>						
Continuous Current	I <sub>S</sub>				-19	A
Forward Voltage <sup>1</sup>	V <sub>SD</sub>	I <sub>F</sub> = -10A, V <sub>GS</sub> = 0V			-1.2	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = -10A, dI <sub>F</sub> /dt = 100A / μS		51		nS
Reverse Recovery Charge	Q <sub>rr</sub>			52		nC

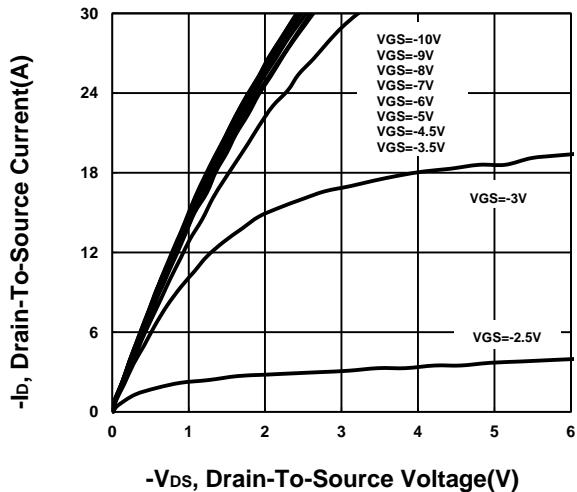
<sup>1</sup>Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.<sup>2</sup>Independent of operating temperature.

**NIKO-SEM**

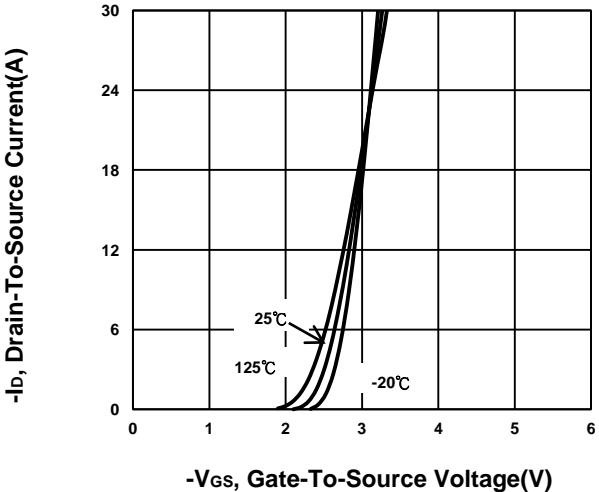
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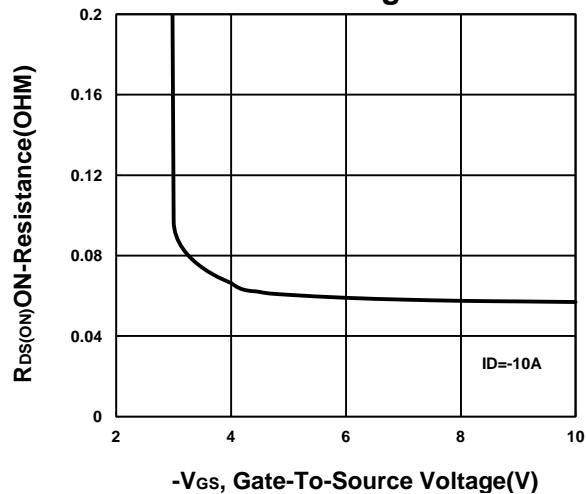
**Output Characteristics**



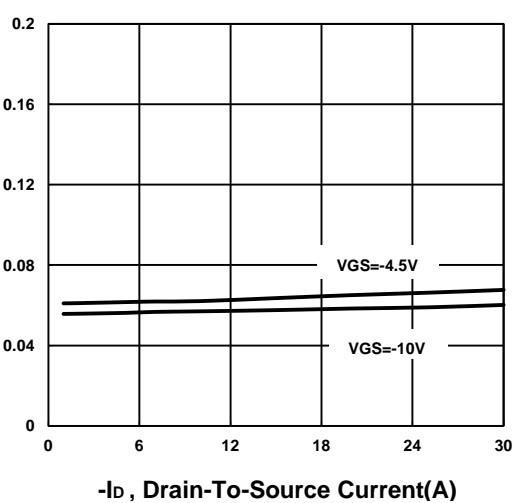
**Transfer Characteristics**



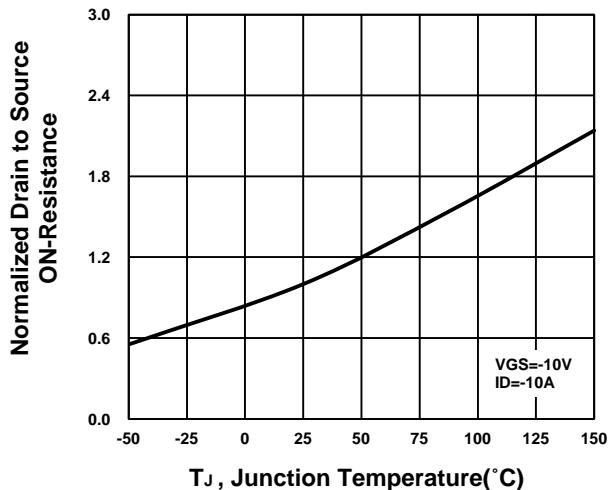
**On-Resistance VS Gate-To-Source Voltage**



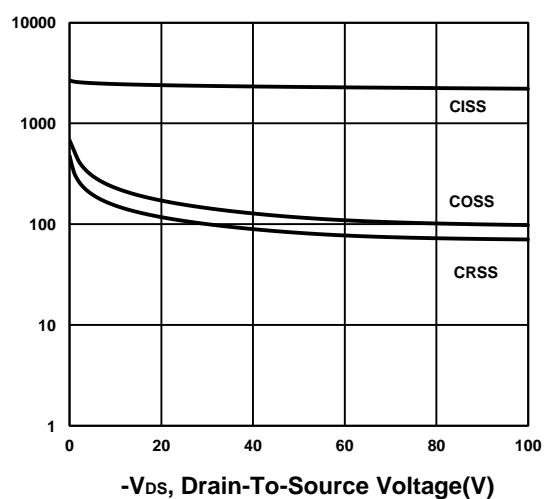
$R_{DS(on)}$  ON-Resistance(Ohm)



**On-Resistance VS Temperature**



$C$  , Capacitance(pF)

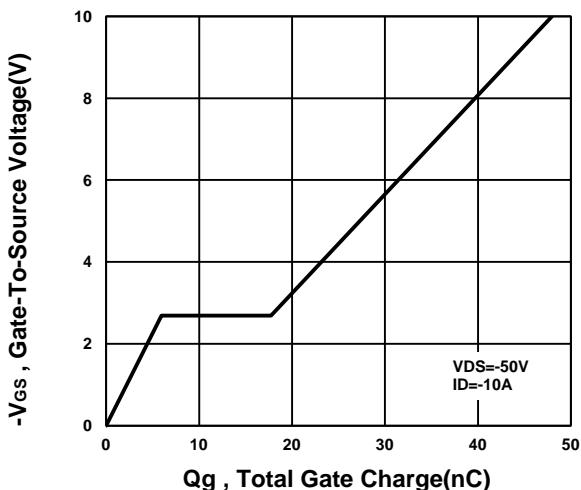


**NIKO-SEM**

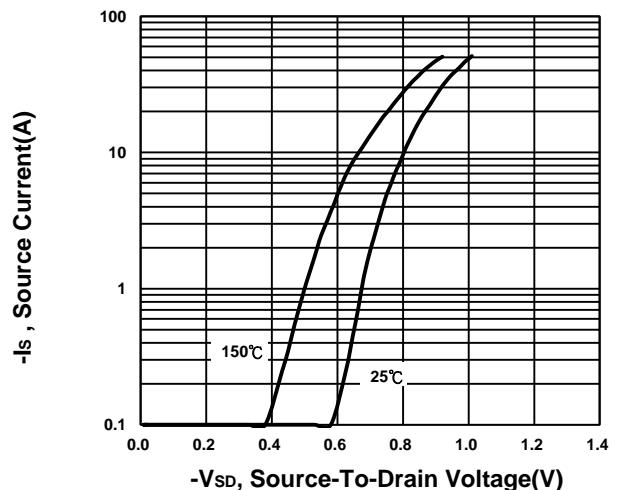
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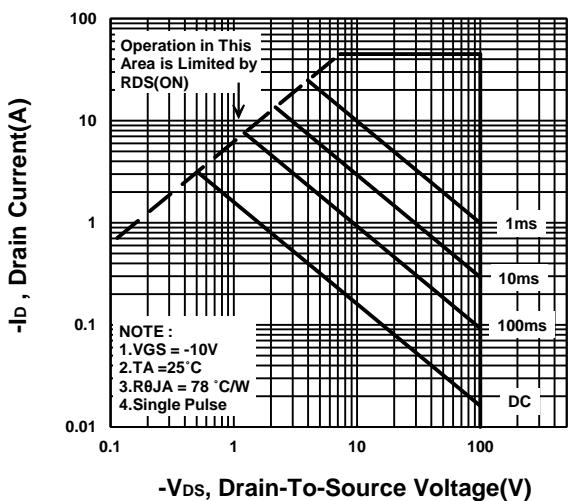
**Gate charge Characteristics**



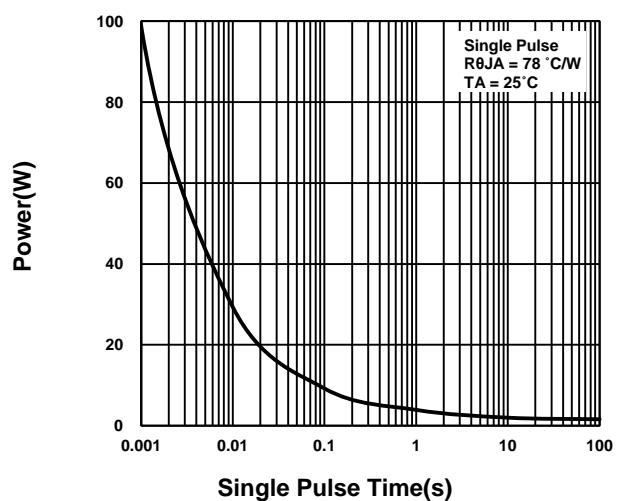
**Source-Drain Diode Forward Voltage**



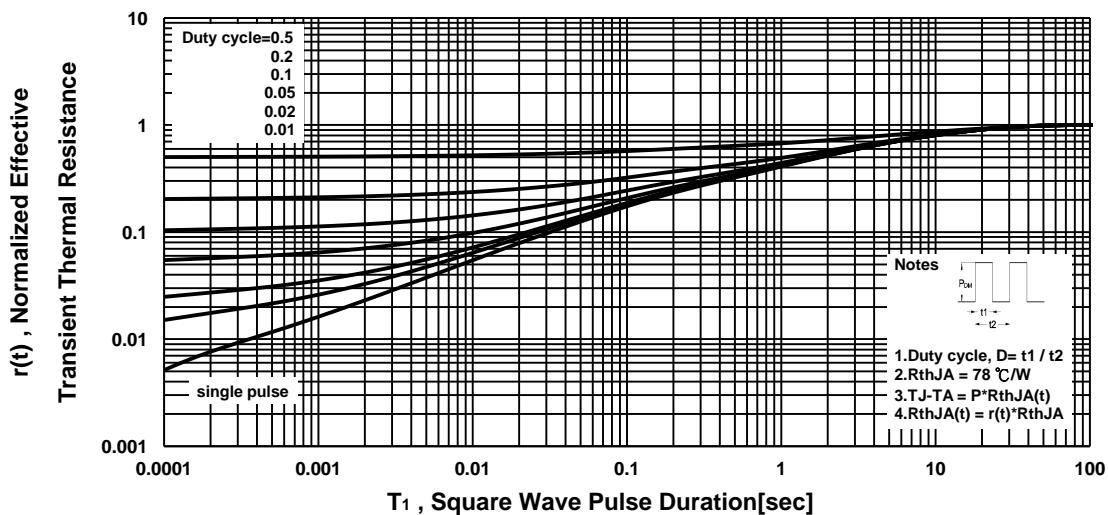
**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**



**NIKO-SEM**

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